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LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT

ATTY. DOCKET NO.: P67191US0
SERIAL NO.: 09/926,531
APPLICANT(S): Per-Erik NORDAL

GROUP ART UNIT: 2831
FILING DATE: November 15, 2001

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE (If Appropriate)
<u>HVN</u>	AA	<u>5,093,708</u>	<u>3/1992</u>	<u>SOLOMON</u>	<u>257</u>	<u>700</u>
<u>HVN</u>	AB	<u>5,502,289</u>	<u>3/1996</u>	<u>TAKIAR ET AL.</u>	<u>174</u>	<u>266</u>
<u>HVN</u>	AC	<u>6,004,825</u>	<u>12/1999</u>	<u>SEYYEDY</u>	<u>438</u>	<u>3</u>
	AD					
	AE					
	AF					
	AG					
	AH					
	AI					
	AJ					
	AK					

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSLATION (YES) (NO)
<u>HVN</u>	AL	<u>0 522 518</u>	<u>1/1993</u>	<u>EUROPE</u>	<u>—</u>	<u>—</u>
	AM					
	AN					
	AO					
	AP					

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

<u>HVN</u>	AR	<u>Patent Abstract of Japan, JP-58-178547 (Matsushita Denki Sangyo K.K.) January 20, 1984, Vol. 8, No. 13</u>
<u>HVN</u>	AS	<u>A Review of 3-D Packaging Technology, IEEE Transactions on Components, Packaging, and Manufacturing Technology, Part B, Vol. 21, No. 1, February 1998</u>

EXAMINER

Hmy VNg

DATE CONSIDERED

031803

* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).